

Facing New Space Challenges European Scalable Solutions



A Leading Provider of Smart, Connected and Secure Embedded Control Solutions



SMART | CONNECTED | SECURE

September 21st, 2023

Largest Space Semiconductors Portfolio

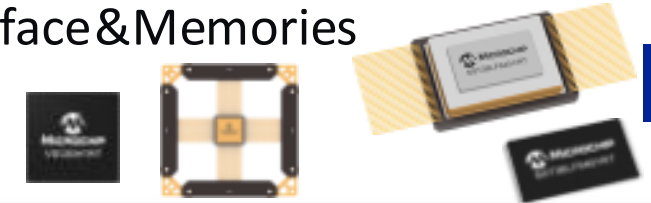
MPU and MCUs

32-bit arm M3 & M7 and SPARC V8
8-bit AVR
GNSSSoC



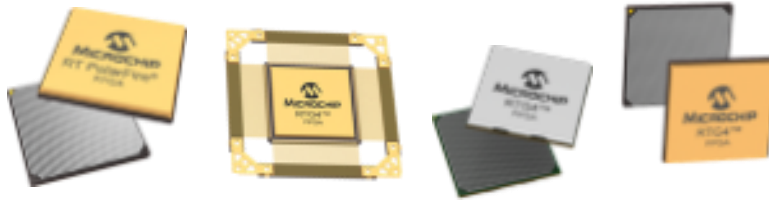
Communication Interface & Memories

Ethernet, SpaceWire
SRAM Memories
NVM Memories



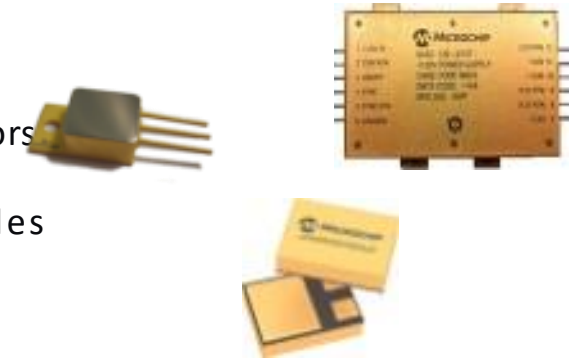
FPGAs

RT PolarFire
RTG4
RT ProASIC3
RTAX, RTSXSU



Power Solutions

JANS Diodes
Bipolar Small Signal Transistors
MOSFET
Isolated D-DC Converter Modules
Point of Load Hybrid Solutions
Electromechanical Relays



Mixed Signal Integrated Circuits

Telemetry Controller
Motor/Position Controller
Power Supply protection



RF Solutions

Packaged and Chip Silicon GaAs RF Diode
Surface Acoustic Wave (SAW) filters
GaAs MMICs
GaNonSiCHEMT transistors

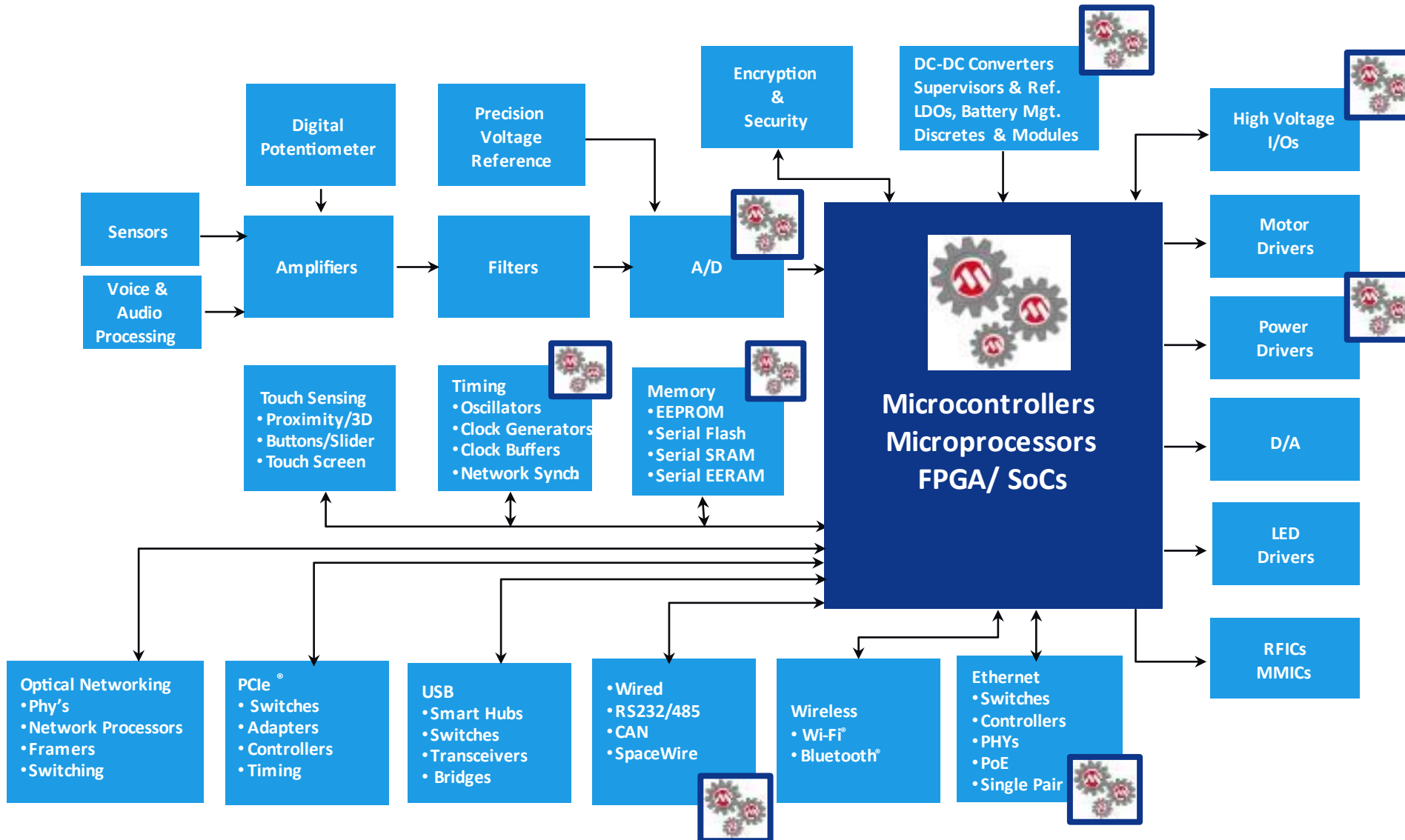


Timing solutions & Oscillators

Ovenized Quartz Oscillators
Voltage Controlled Crystal Oscillators
Temperature Compensated Crystal Oscillators
Cesium Clocks
Chip Scale Atomic Clock (CSAC)



Drive innovation around processing solutions



Ethernet PHYs

Gbit/10Gbit

Switches 1588/TSN

PCIe solutions

Security devices

Flash/EEPROM

Power Modules

Clock Management



NewSpace Challenges / Semiconductors

- **Cost reduction** (but still low volume)
 - Recurrent costs @component level (RE)
 - Development costs @system level (NRE)
- **Development lead time pull in**
 - Driven by a shorter time ROI
- **Performances & Quality leverage**
 - Depending on mission, duration, orbit but also risk management
- **New actors coming from industrial/automotive**
 - Looking for easy access solution with known technology (eg. Ethernet)
 - Bidding on different opportunities from class 1 space agencies program to mega LEO small sat constellations.
- **Semiconductors technology** driven by commercial with more advanced technologies & « System on Chip » => **more SEE events and higher access costs**



Space Evolution with Microchip

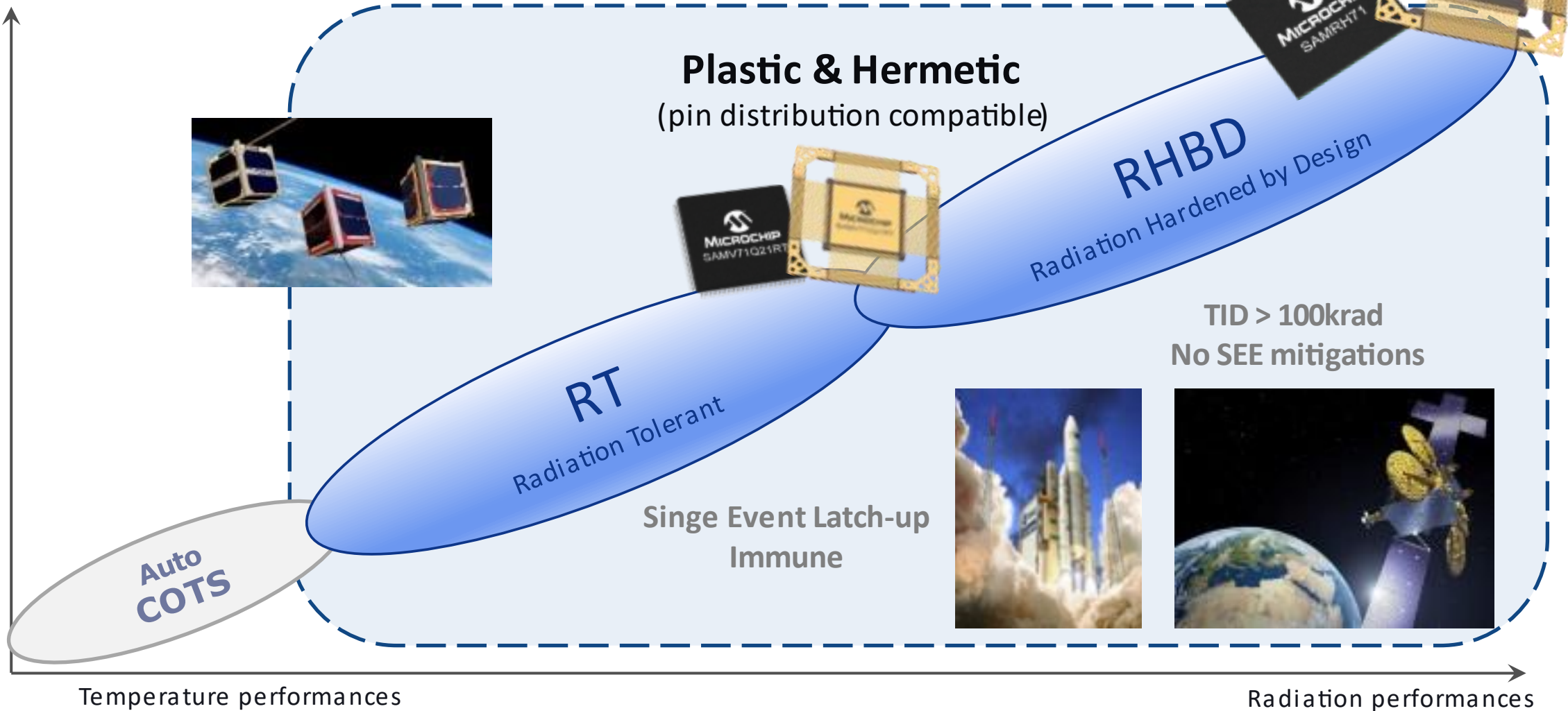
Hirel Plastic * Rad Tolerant * Rad Hard



- **Commercial leadership**
 - Very high -volume COTS supplier
 - MCU & FPGA Market leader
 - Connectivity - Ethernet
 - Security
- **Leader in Space**
 - Number 1 for Semiconductors
 - Strong flight heritage
 - Radiation expertise
 - JANS/ QML/ ESCC portfolio
- **Customization capabilities**
 - Bridge from COTS to RT
 - Bridge from QML to Sub QML
 - Scalability

Scalable solutions from COTS to Class 1

Quality Grade



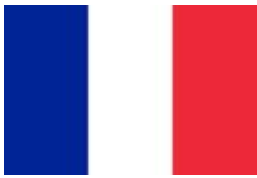
Hirel Plastic vs. COTS Automotive

- Ensure **full traceability** : Single Fab & Assembly w Dedicated Wafers
- Access to « Single Lot Date Code »
- Extended temperature range to -55/+125°C (according to rad perms)
- Low MOQ : hundred of units

- **Reliability** verified on the **full temperature range**
- Extended qual. : HAST, Life Tests, Temp Cycling ... → prod spec & CoC
- **Full access to Qualification Data** (Qual Pack)

- Extra screening options : Burn-in, Temp Cycling, ...
- **Extension towards QML-P / ESCC900P** standard qualification level

COTS to Space Qualified RT @ Microchip

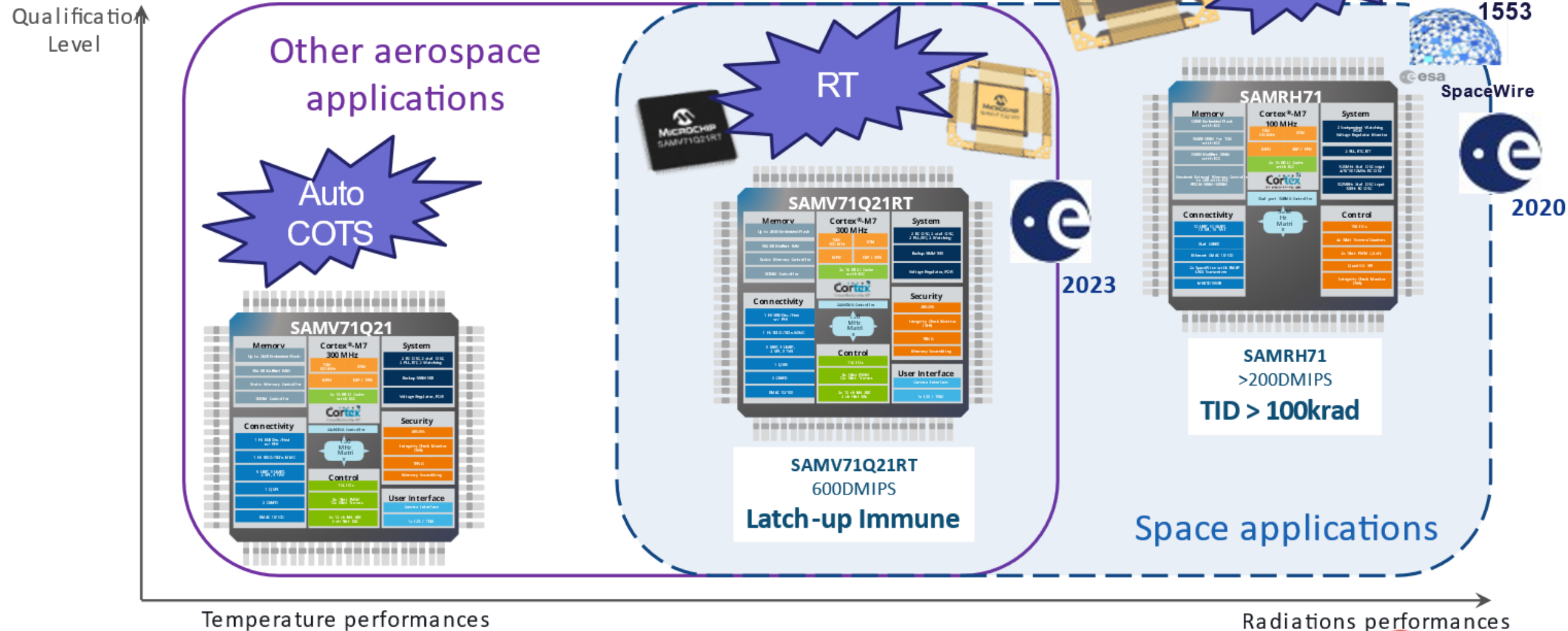


1. **Identify industry needs, share roadmaps & input from other domains(eg. auto)**
2. **Select device in the Microchip's portfolio**
 - Select the best Design/Technology couple. Based on our experience, we select potential winners.
3. **Assess the device by simulation against SEE and TID using :**
 - Based Technology information (Foundries)
 - And Design data base (GDSII)
4. **Radiations Tests / defined boundary conditions**
 - TID : To characterize the product capability
 - SEE : To evaluate destructive events
 - Single Event Latchup- Single Event Gate Rupture Single Event Burnout
5. **Product improvements towards RT level (process, fix, spec, ...)**
6. **Qualification for space applications including radiations (SEU & TID)**
 - SEU : Characterization of all functional blocks of the device
 - Space qualification according to space standards / Ceramic & Plastic
7. **RT datasheet, radiation report and mitigation guidelines**
8. **Introduce and support COTS RT on space market w a dedicated team**
9. **Products belongs to French Export Control when all activities done in France**



Arm® M7 SoC → COTS to Rad Hard by Design

Unique Scalable Solution



SAMV71Q21		
Memory Up to 384 Embedded Flash 16.384KB SRAM Main Memory Control for SDRAM Control for	Cortex®-M7 300 MHz M7D1 M7D2 / M7D3	System 2.8K DTC and DTC 2.8K DTC Marking Backup SRAM Multi-Region for PCP
Connectivity 1x 1000Base-T Ethernet 1x 1000Base-T Ethernet 1x USB 1x CAN 1x I2C 1x SPI	Control 1x 1000Base-T Ethernet 1x 1000Base-T Ethernet	Security Energy Check Module SRAM Memory Scrambling User Interface Serial Interface 1x I2C / 100k

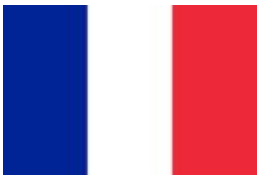
SAMV71Q21RT		
Memory Up to 384 Embedded Flash 16.384KB SRAM Main Memory Control for SDRAM Control for	Cortex®-M7 300 MHz M7D1 M7D2 / M7D3	System 2.8K DTC and DTC 2.8K DTC Marking Backup SRAM Multi-Region for PCP
Connectivity 1x 1000Base-T Ethernet 1x 1000Base-T Ethernet 1x USB 1x CAN 1x I2C 1x SPI	Control 1x 1000Base-T Ethernet 1x 1000Base-T Ethernet	Security Energy Check Module SRAM Memory Scrambling User Interface Serial Interface 1x I2C / 100k

SAMRH71		
Memory Up to 384 Embedded Flash 16.384KB SRAM Main Memory Control for SDRAM Control for	Cortex®-M7 100 MHz M7D1 M7D2 / M7D3	System 2.8K DTC and DTC 2.8K DTC Marking Backup SRAM Multi-Region for PCP
Connectivity 1x 1000Base-T Ethernet 1x 1000Base-T Ethernet 1x USB 1x CAN 1x I2C 1x SPI	Control 1x 1000Base-T Ethernet 1x 1000Base-T Ethernet	Security Energy Check Module SRAM Memory Scrambling User Interface Serial Interface 1x I2C / 100k

SAMV71Q21RT
600DMIPS
Latch-up Immune

SAMRH71
>200DMIPS
TID > 100krad

Scalable & Plastic solutions



• COTS Rad Tolerant

Products	Type	Summary / Highlights	Flight Models
ATmegaS128	MCU AVR8	~10 DMIPS,SPI,TWI,UART,ADC	2017
ATmegaS64M1	MCU AVR8	~10 DMIPS, CAN,DAC and Motor Control	2017
SAMV71Q21RT	MCU ARM M7	600 DMIPS, CANFD, Ethernet TSN, DSP	2018
SAM3X8ERT	MCU ARM M3	100 DMIPS, CAN, Ethernet, Dual CAN	2020
VSC8541RT	Ethernet PHY	100Mb/1Gbit Ethernet Transceiver, RMII/RGMII	2020
SST38LF6401RT	Parallel Flash	64 Mbit Parallel Rad Tolerant Flash Memory	2021
SST26LF064RT	Serial Flash	64 Mbit Serial Rad Tolerant Flash Memory	2022



• Rad hard by Design

Products	Space Techno	Summary / Highlights	Flight Models
SAMRH71 MPU ESCC9512006	ATMX150RHA	Arm CortexM7, >200 DMIPS Spw/1553/CAN FD/Eth, TCM/FPU/MPU/ECC	2020
SAMRH707 MCU	ATMX150RHA	Arm CortexM7, 100 DMIPS Spw/1553/CAN FD,ADC/DAC, NVM+, small package	2023



Time is the Essence of New Space

Reducing development costs leads to reduce development cycles

Microchip proposes « **System Use Cases** » to boost your development lead times & ease your system design:

- Suggesting a list of Microchip components working together
- Providing hardware example associating some Microchip components
- Developing software examples to interact with other Microchip components
- Demonstrating application use cases at system level
- Offering application notes, tools and presentations to ease customer system integration with Microchip components



Summary – New Space Challenges

- **Microchip A&D product lines in Europe**
 - Contributing to largest Space products portfolio
 - Drive space system innovation around processing solutions
- **New Space Challenges / Semiconductors**
 - Costs, Schedules, ROI, New players, Technology trend, ...
- **Scalable Solutions for New Space in Europe**
 - COTS upgrade to qualified plastic & ceramic for space
 - Solutions from Europe : MCU/MPU, Ethernet, Memories, ...
 - System use cases to reduce development lead times

Thank You !

Aerospace & Defense Group - Product Marketing
Microchip Technology Nantes S.A.S.

Microchip Aerospace & Defense Website:

<https://www.microchip.com/design-centers/aerospace-and-defense>

Microchip Technical Support: <https://microchipsupport.force.com/s/>

